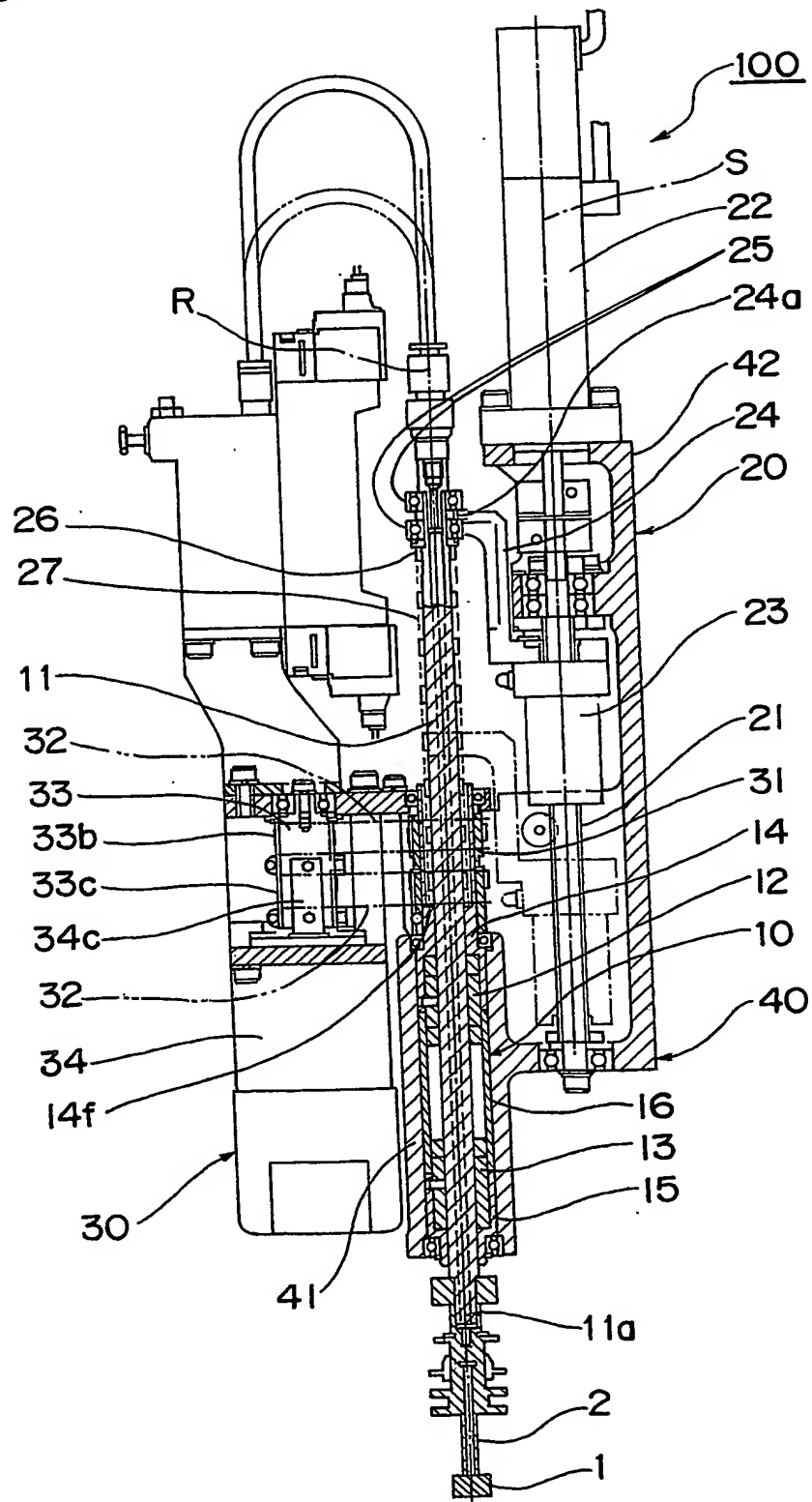


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Fig. 1



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Fig. 2

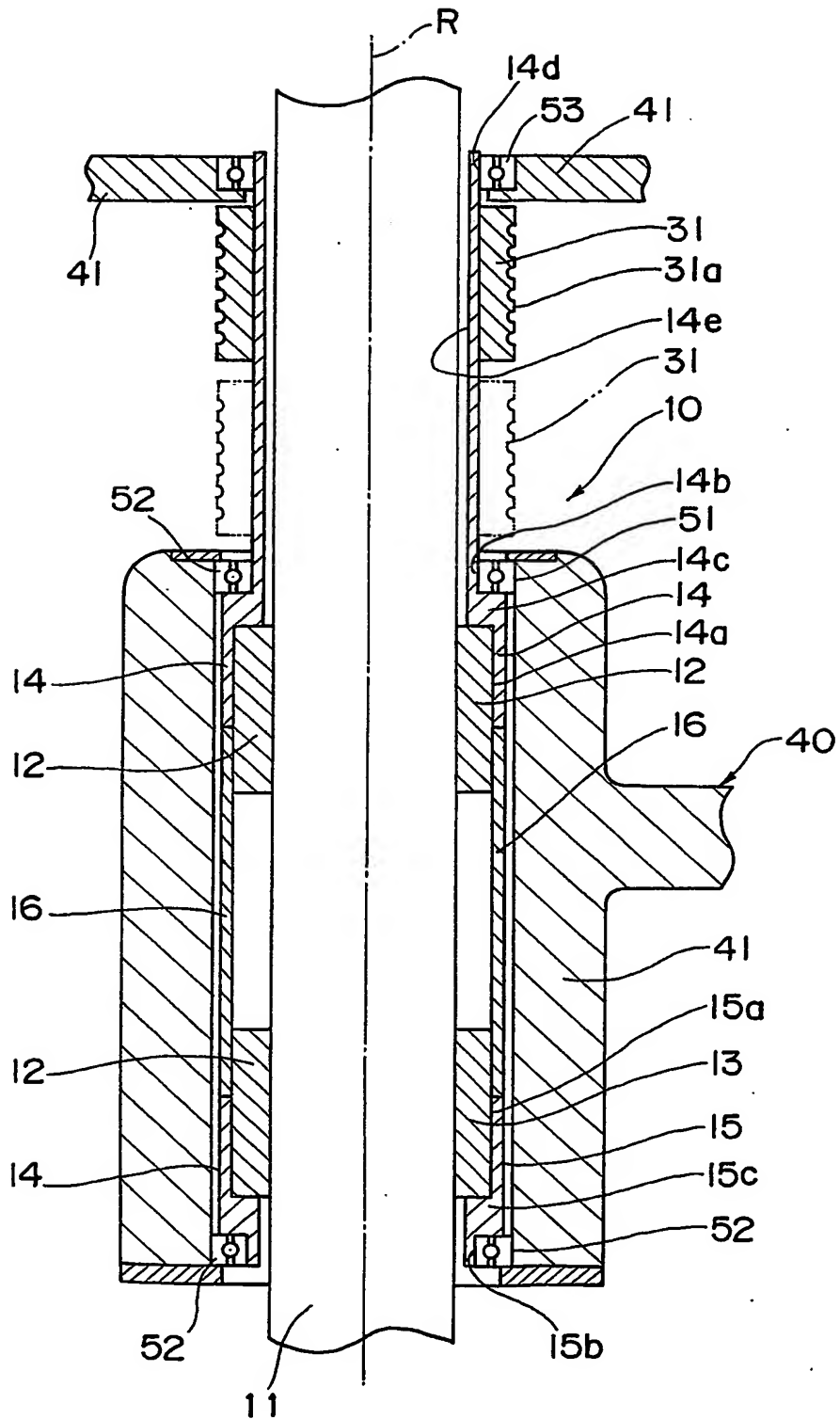
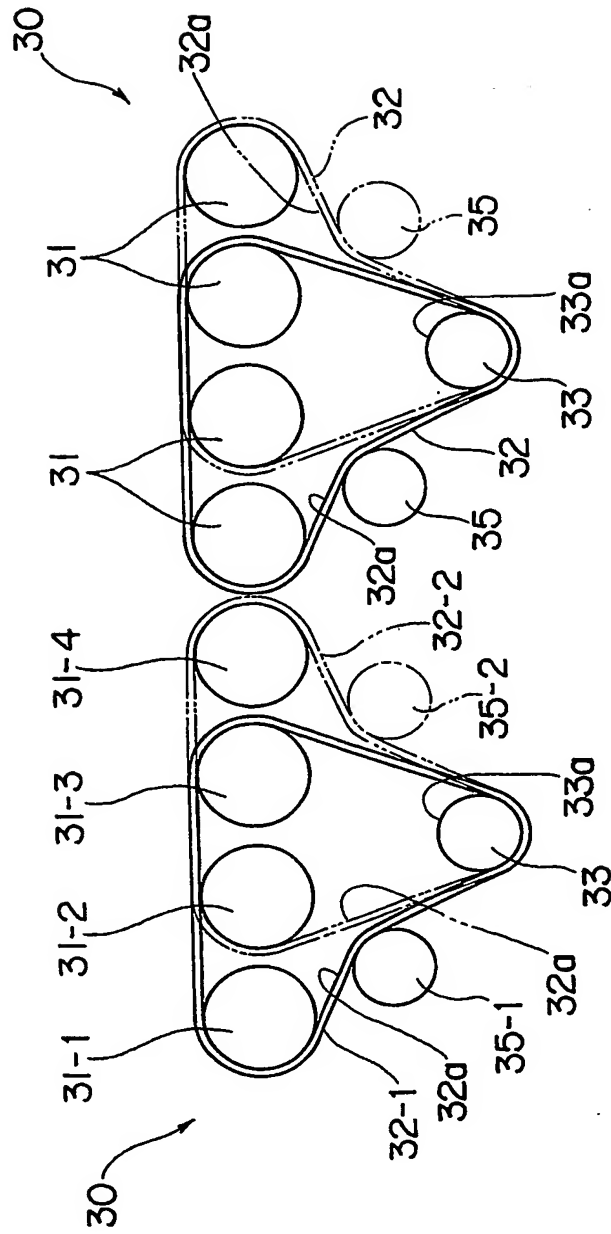
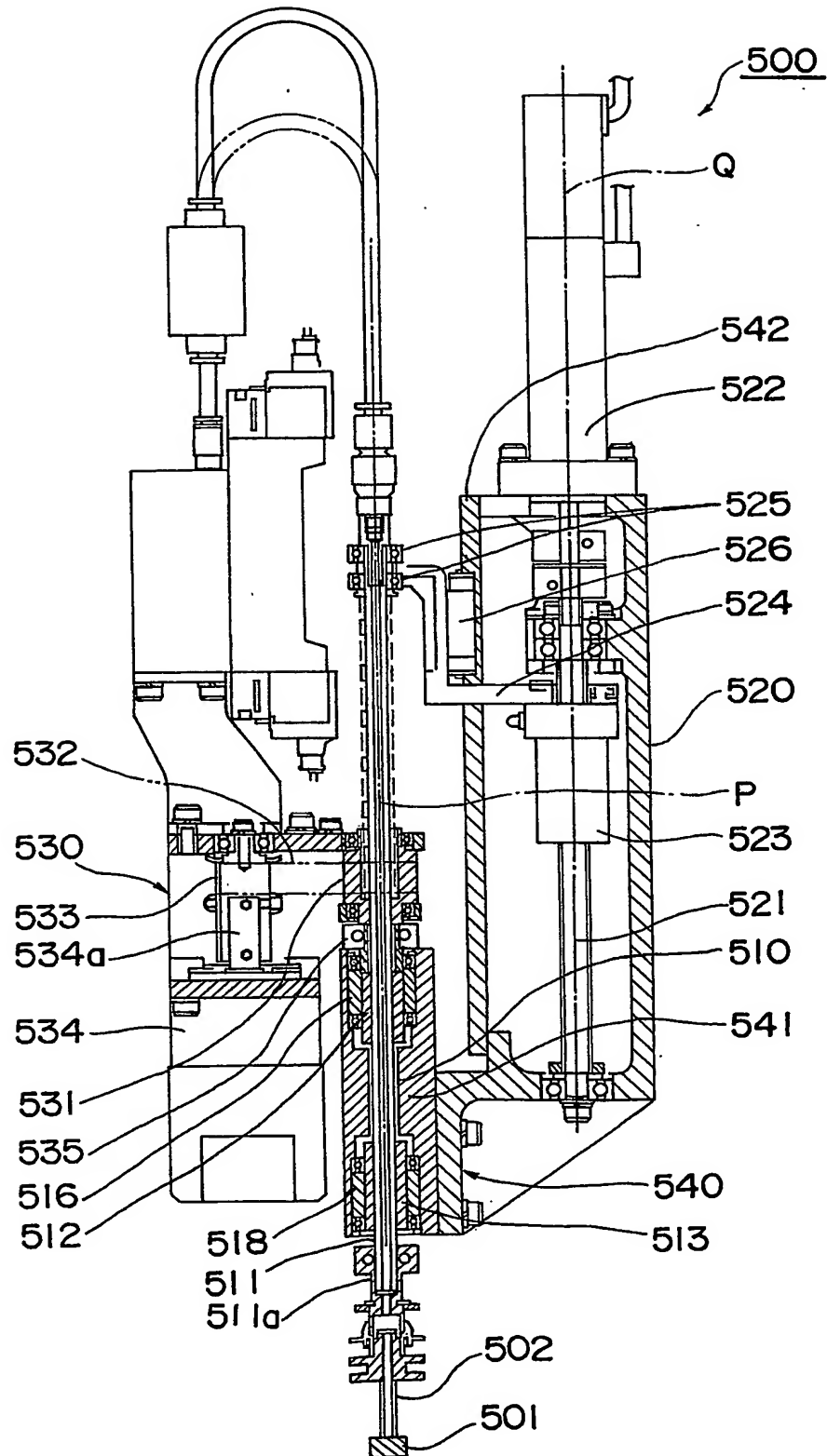


Fig. 3



**Fig. 4**



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Fig. 5

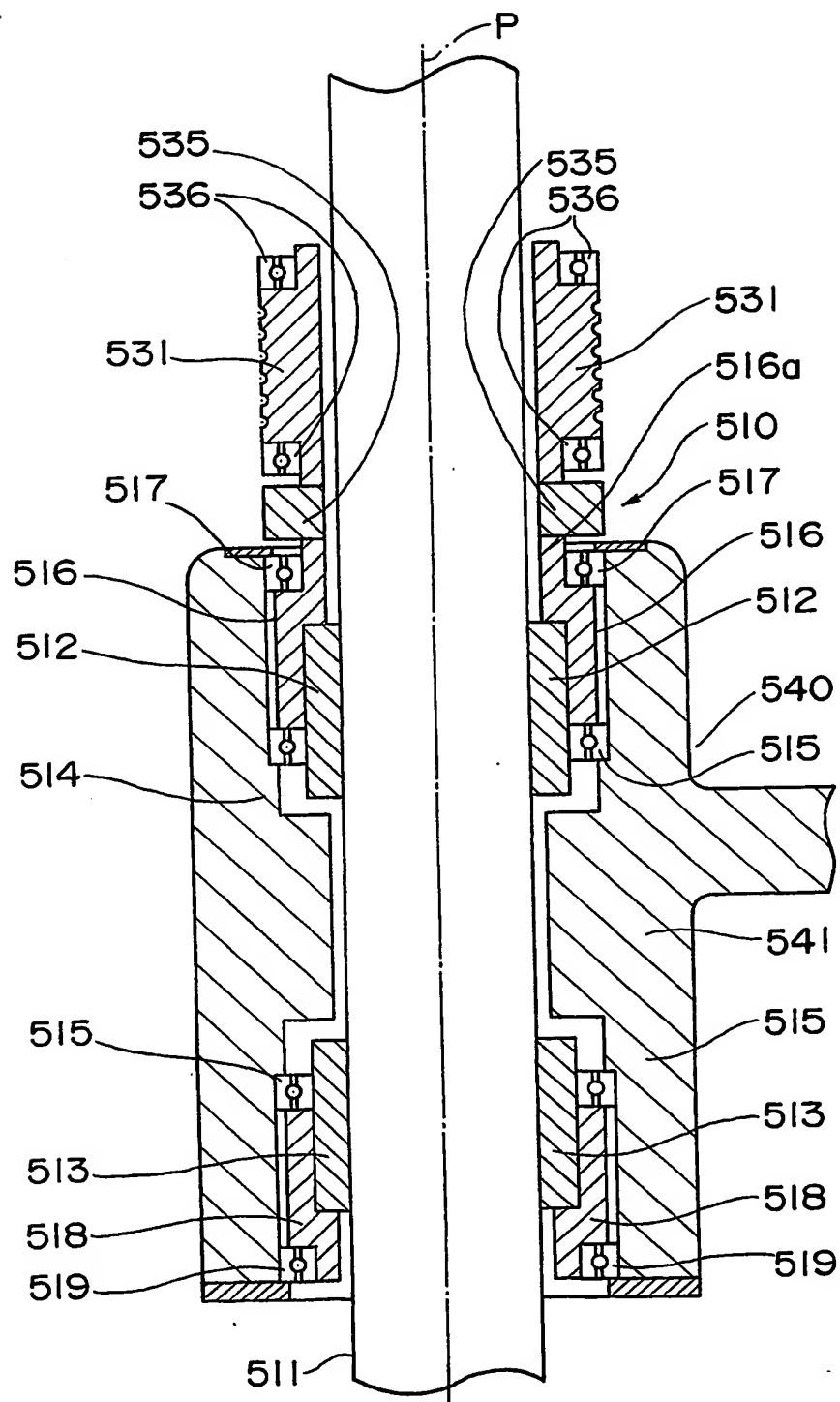
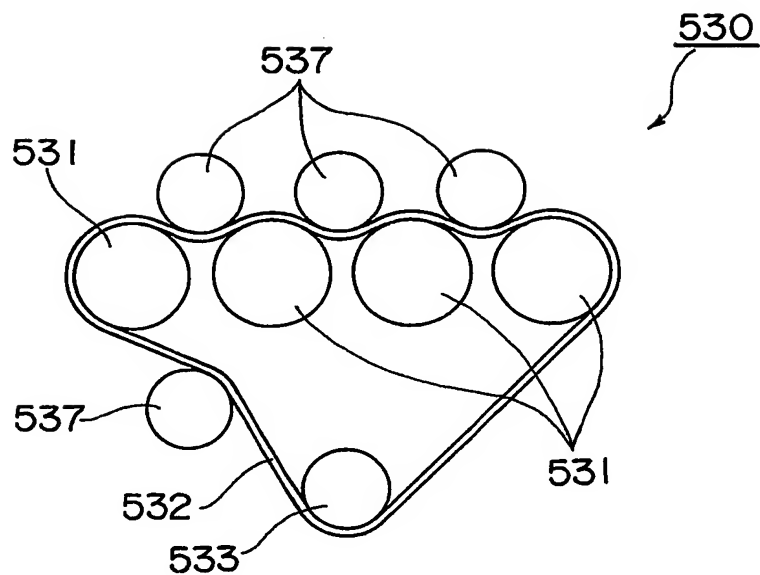
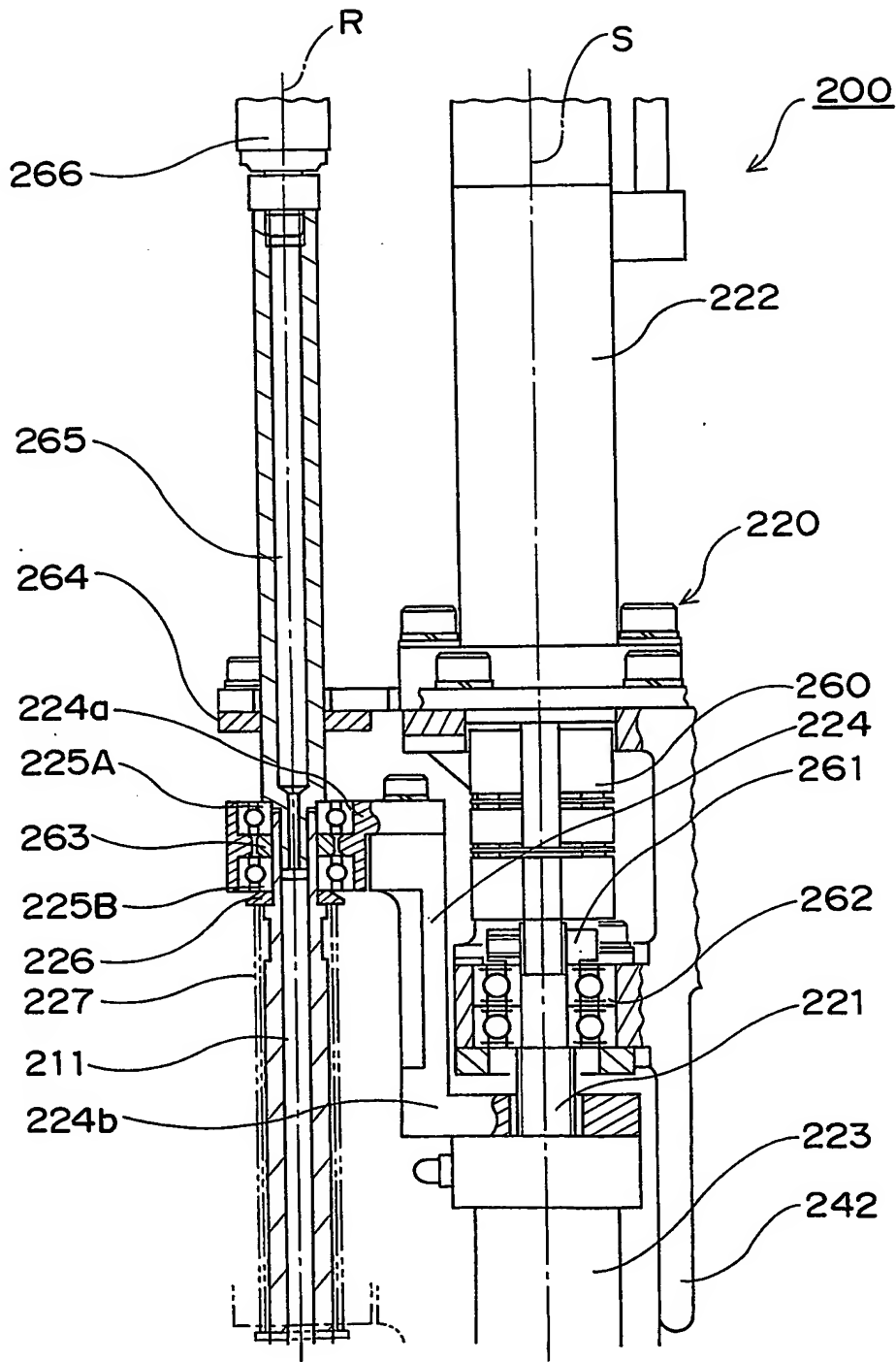


Fig. 6



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Fig. 7







This diagram shows a cross-section of a semiconductor device. It features two horizontal rows of rectangular elements, labeled 60 (top) and 61 (bottom), which are interconnected by vertical conductive pillars or vias labeled 62. The top row 60 includes a label 21 pointing to its left side and 22 pointing to one of its units. The bottom row 61 has labels 61a at its left edge and 62a at its right edge. A dashed line labeled T indicates a specific interface or layer between the two rows. Vertical arrows labeled A point upwards from the bottom row towards the top row. A reference numeral 300 points to the overall assembly.

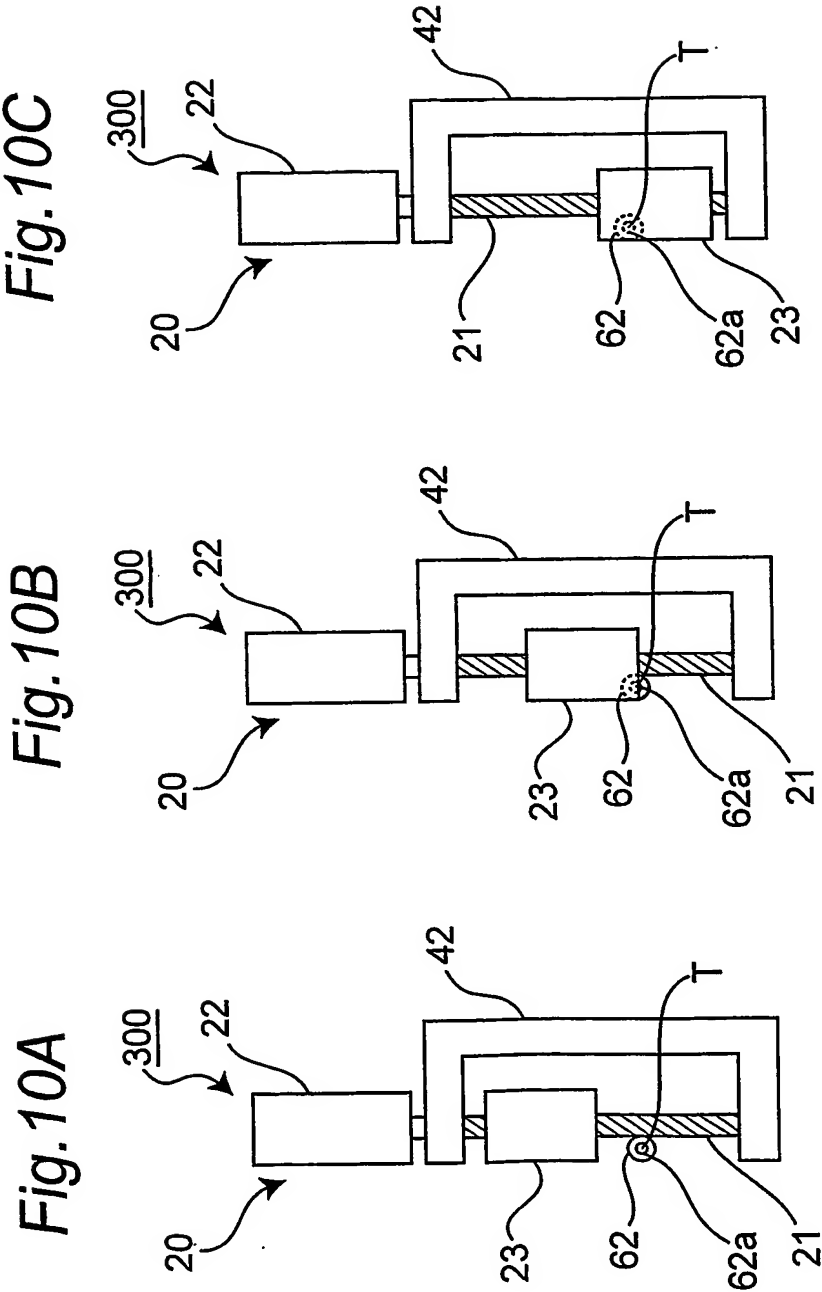
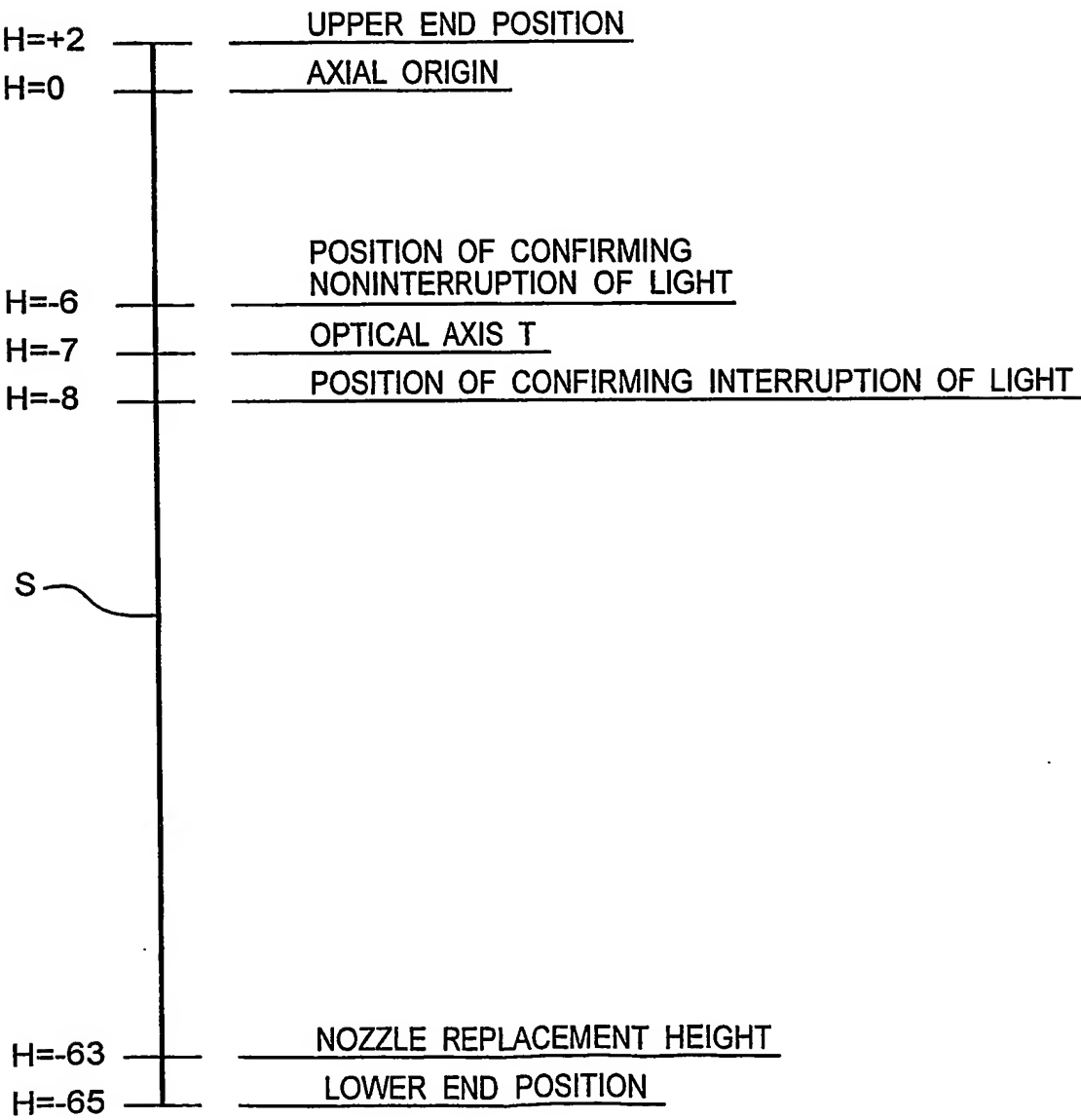
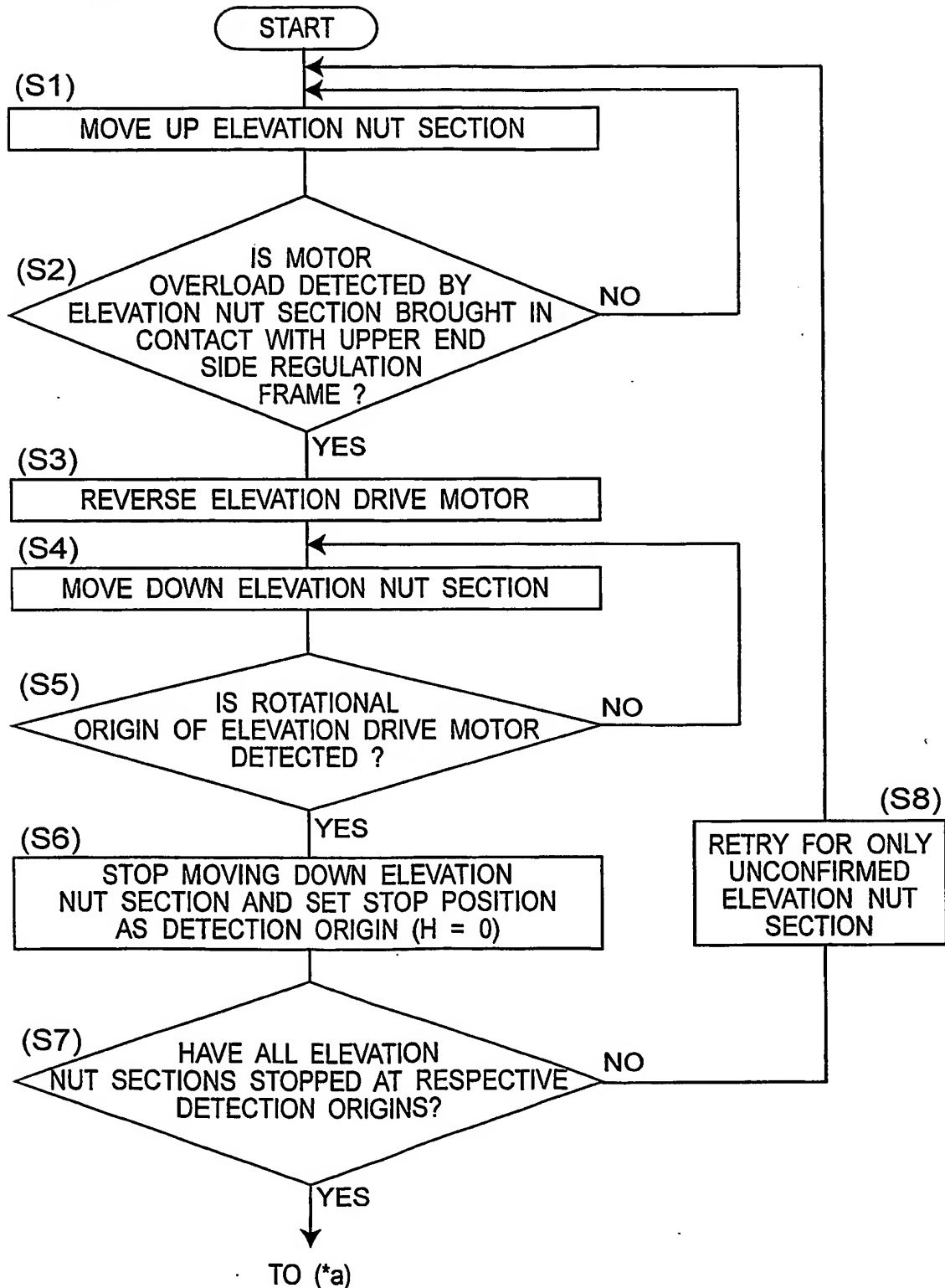


Fig. 11



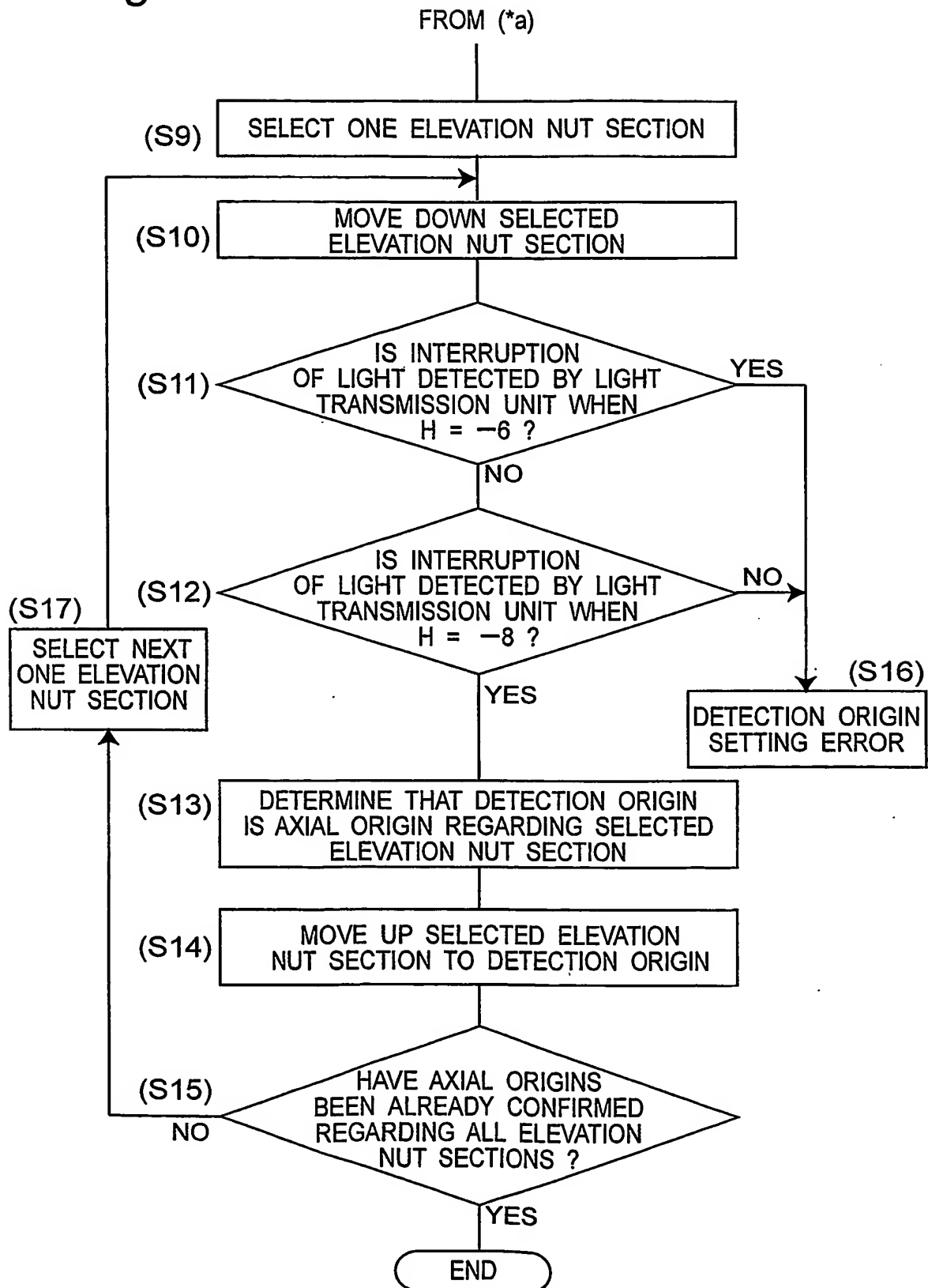
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Fig. 12



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Fig. 13



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*Fig. 14*